

8-Channel 1-wire Dimming Parallel White LED Driver with Ultra Low Dropout Current Source

Features

- Drive up to 8 LEDs with 20mA maximum current
- Q-Mirror™ technique ensuring LEDs current matching accuracy $\pm 5\%$ (typical)
- Ultra low dropout: 50mV/20mA (typical)
- 2.8V to 5.5V operating input voltage range
- 16-step linear scale LED brightness control
- Deglitch circuit eliminating interference at EN pin
- No EMI and switch noise
- Less than 0.1 μ A quiescent current in shutdown mode
- Thermal shutdown protection
- WQFN 3mmx3mmx0.75mm-16L package

Applications

- Mobile phone
- Digital camera
- PDA, MP3

Description

The AW9358B is an 8-channel parallel white LED driver with ultra low dropout constant-current source. The AW9358B can drive 8 LEDs and each LED's maximum current is up to 20mA which is set by the internal resistor. The proprietary Q-Mirror™ technique is used in the AW9358B, which makes the 8 LEDs current matching to $\pm 5\%$.

The AW9358B use 1-Wire Brightness Control, 16-Step Linear Scale LED Brightness Control, which effectively avoid the interference caused by the PWM dimming mode.

The AW9358B has an internal deglitch circuit can effectively eliminate the influence of the glitch signal for EN input. The AW9358B requires only a 50mV (typical) dropout voltage at a 20mA load. The feature makes AW9358B ideal for battery-operated systems, such as personal digital assistants. The AW9358B only need one ceramic capacitor making the system design easier, and use less PCB. The shutdown current of the AW9358B is less than 0.1 μ A.

The AW9358B is available in QFN 3mmx3mmx0.75mm-16L package and is specified over the -40°C to +85°C temperature range.

Typical Application Circuits

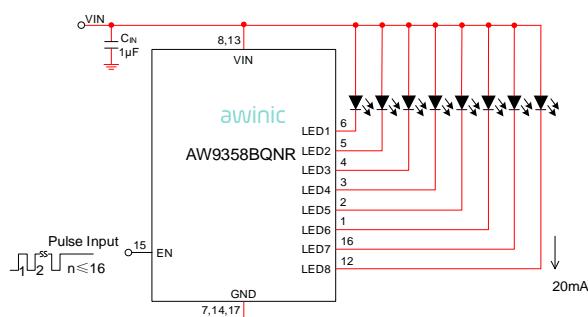


Figure 1 AW9358B Typical Application

Pin Configuration And Top Mark

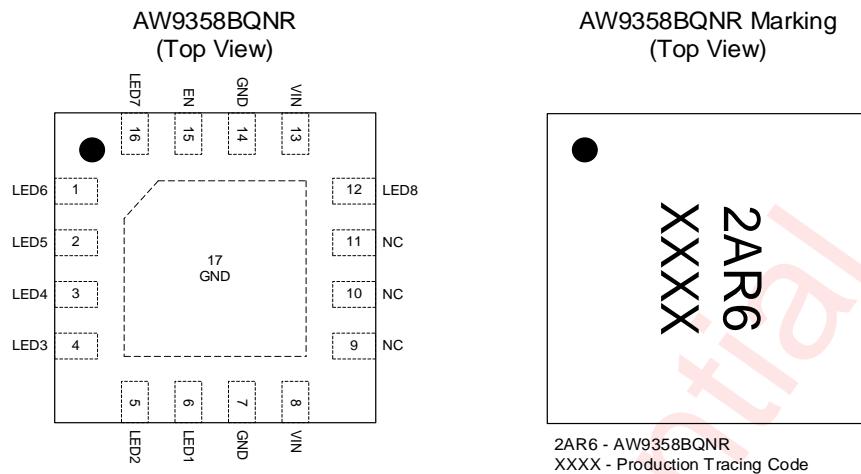


Figure 2 Pin Configuration of AW9358B

Pin Definition

| PIN | Symbol | Description |
|------|--------|--|
| 1 | LED6 | Current sink for LED6 |
| 2 | LED5 | Current sink for LED5 |
| 3 | LED4 | Current sink for LED4 |
| 4 | LED3 | Current sink for LED3 |
| 5 | LED2 | Current sink for LED2 |
| 6 | LED1 | Current sink for LED1 |
| 7 | GND | Ground |
| 8 | VIN | Power supply Input |
| 9-11 | NC | No connect |
| 12 | LED8 | Current sink for LED8 |
| 13 | VIN | Power supply Input |
| 14 | GND | Ground |
| 15 | EN | Enable pin. Active high, with an internal 150kΩ pull-down resistor |
| 16 | LED7 | Current sink for LED7 |
| 17 | GND | Ground |

AWINIC LED Driver Series

| Product | Channels | Type | Description | Package |
|---------|----------|--------------|---|---------|
| AW9358B | 8 | Current Sink | 8 Independent 1-wire Configurable 20mA LED Driver | QFN-16L |
| AW9364 | 4 | Current Sink | 4 Independent 1-wire Configurable 20mA LED Driver | DFN-8L |
| AW9364B | 4 | Current Sink | 4 Independent 1-wire Configurable 20mA LED Driver | DFN-8L |

Typical Application Circuits

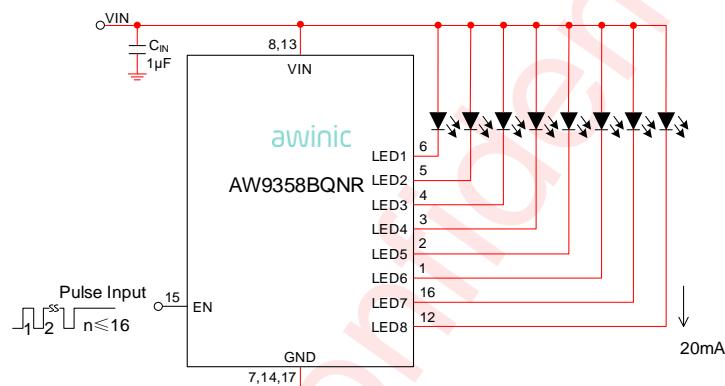


Figure 3 AW9358B Typical Application

Notice for Typical Application Circuits:

- 1: Please place C_{IN} as close to the chip as possible.
- 2: For the sake of driving capability, the power lines and the connection lines of LED should be short and wide as possible.
- 3: The power path marked in red as shown in the figures above.

Ordering Information

| Part Number | Temperature | Package | Marking | Moisture sensitivity level | Environmental Information | Delivery Form |
|-------------|-------------|-------------------------------|---------|----------------------------|---------------------------|--------------------------------|
| AW9358BQNR | -40°C~85°C | QFN 3mmx3mmx 0.75mm-16L | 2AR6 | MSL3 | RoHS+HF | 6000 units/Tape and Reel |

Absolute Maximum Ratings^(NOTE1)

| Parameter | | Range |
|--|-----------|---------------------------|
| Supply voltage range VIN | | -0.3V to 6 V |
| Input voltage range | EN | -0.3V to 6V |
| Output voltage range | LED1~LED8 | -0.3V to 6V |
| Junction-to-ambient thermal resistance θ_{JA} | | 79°C /W |
| Maximum operating junction temperature T_{JMAX} | | 125°C |
| Storage temperature T_{STG} | | -65°C to 150°C |
| Lead temperature (soldering 10 seconds) | | 260°C |
| ESD (NOTE 2) | | |
| HBM | | ±2kV |
| CDM | | ±1.5kV |
| Latch-Up | | |
| Test method: JEDEC JESD78F-2022 | | +IT: 200mA -IT: -200mA |

Recommended Operating Conditions

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|----------|--------------------------------------|------|------|------|------|
| VIN | Power Supply voltage | 2.8 | 3.6 | 5.5 | V |
| T_A | Operating free-air temperature range | -40 | 25 | 85 | °C |
| C_{IN} | Input capacitor | 0.1 | 1 | 100 | μF |

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5kΩ resistor into each pin. Test method: ANSI/ESDA/JEDEC JS-001-2017. CDM test method: ANSI/ESDA/JEDEC JS-002-2018.

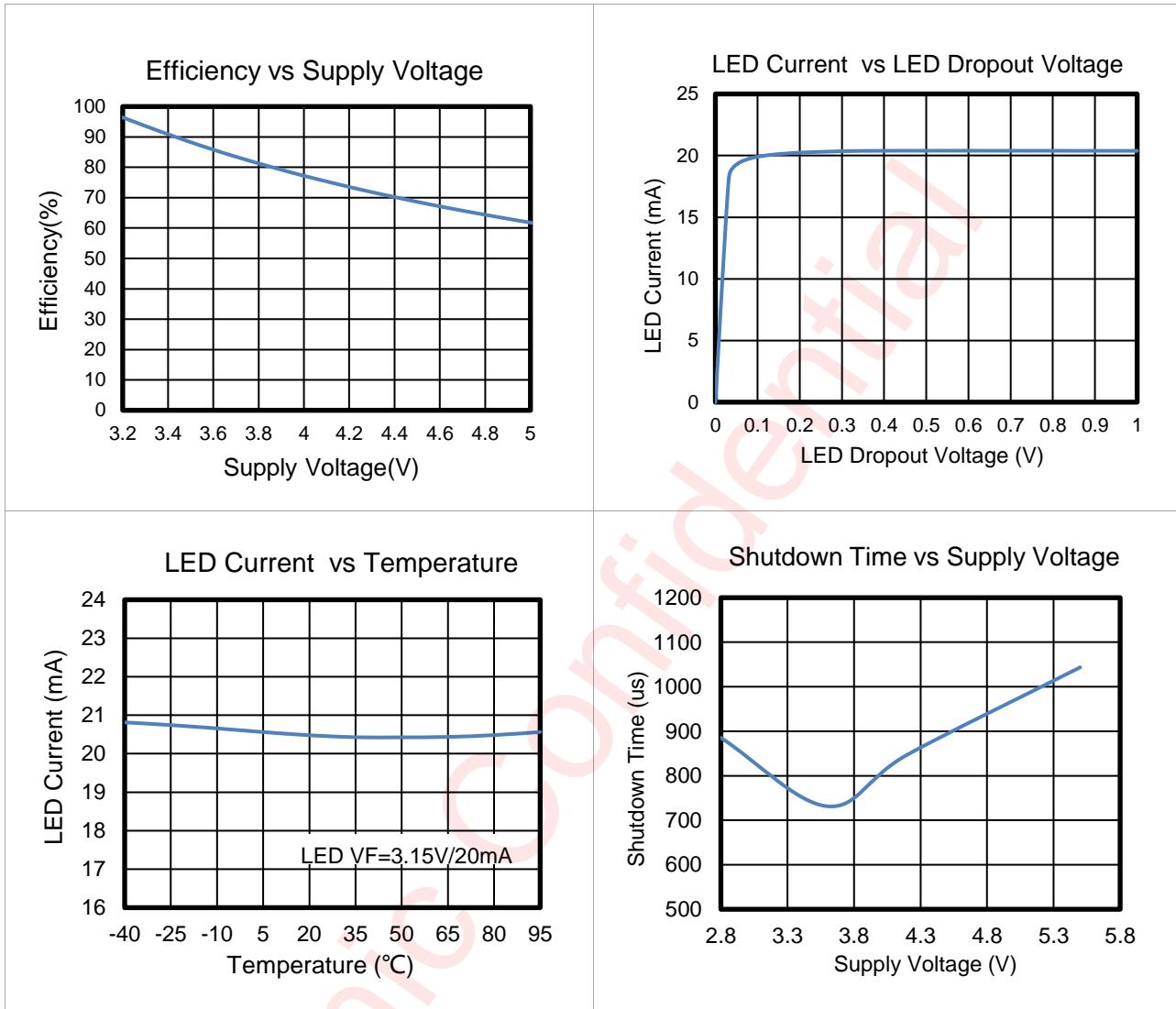
Electrical Characteristics

Test Condition: $T_A=25^\circ\text{C}$, $V_{IN}=3.6\text{V}$, $C_{in} = 1\mu\text{F}$ (unless otherwise specified)

| Symbol | Description | Test Condition | Min | Typ | Max | Units |
|-----------------------------------|----------------------------------|--|------|-----|------|---------------|
| SUPPLY VOLTAGE AND CURRENT | | | | | | |
| V_{IN} | Power Supply Voltage | | 2.8 | | 5.5 | V |
| I_{SD} | Shutdown Current | $V_{EN}=0\text{V}$, $V_{IN}=5.5\text{V}$ | | 0.1 | 1 | μA |
| I_Q | Quiescent Current | $V_{EN}=V_{IN}$, LED Pin floating | | 312 | 475 | μA |
| $I_{LEAKAGE}$ | Output leakage current | $V_{EN}=0\text{V}$, $V_{LEDx}=5.5\text{V}$ | | 0.1 | 1 | μA |
| CURRENT SINK | | | | | | |
| I_{LED} | Output Current | All LEDs 100% setting | 18.5 | 20 | 21.5 | mA |
| ΔI_{LED} | Channel to channel current error | All LEDs 100% setting | -5 | | 5 | % |
| $V_{DROPOUT}$ | LED Dropout Voltage | $I_{LED}=20\text{mA}$ | | 50 | 170 | mV |
| ENABLE | | | | | | |
| V_{IH} | Enable High Level Input Voltage | | 1.3 | | | V |
| V_{IL} | Enable Low Level Input Voltage | | | | 0.3 | V |
| R_{PD} | Pull down resistor of EN Pin | $V_{EN}=0.4\text{V}$ | 50 | 150 | 250 | k Ω |
| T_{ON} | Startup Time | | | 10 | 20 | μs |
| T_{LO} | EN Low Time for Dimming | | 0.5 | | 500 | μs |
| T_{HI} | EN High Time for Dimming | | 0.5 | | | μs |
| T_{OFF} | Shutdown Delay Time | Delay time when pin EN go to low level after which the AW9358B shutdown completely | | 800 | 2500 | μs |
| T_{SD} | Thermal shutdown threshold | | | 150 | | |
| | Thermal shutdown hysteresis | | | 20 | | °C |

Typical Operation Characteristics

Test condition: $T_A=25^\circ\text{C}$, $V_{IN}=3.6\text{V}$, $C_{in} = 1\mu\text{F}$, unless otherwise specified.



Functional Block Diagram

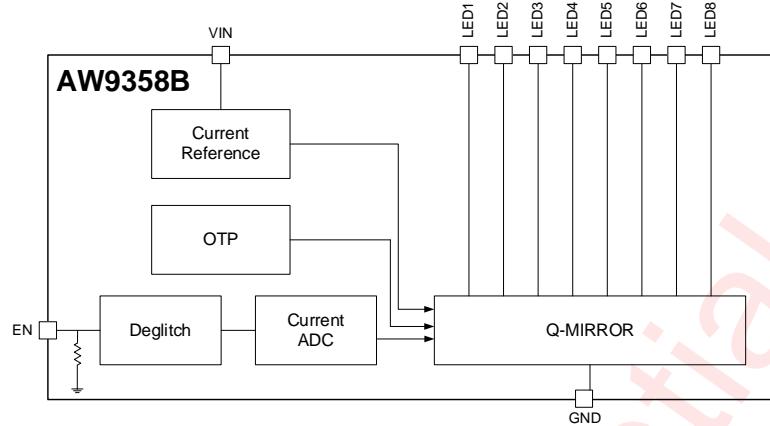


Figure 4 Function Block Diagram of AW9358B

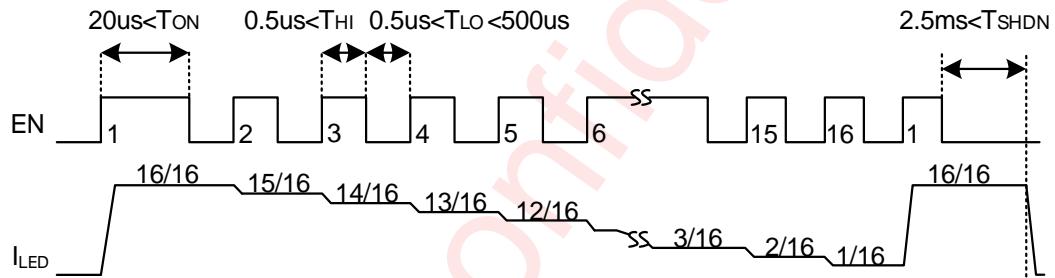


Figure 5 1-wire brightness control Interface Timing of AW9358B

Detailed Description

The AW9358B is an 8-channel parallel white LED driver with ultra low dropout constant-current source. The AW9358B mainly used in new generation mobile phone and portable devices which need lower dropout voltage LED. Each LED's maximum current is up to 20mA which is set by the internal resistor. The AW9358B use 1-wire pulse count dimming mode, realizing 16 step linear adjustable of LED brightness control.

Enable Input

The EN input is used to enable or disable the AW9358B. Pulling the EN pin to high voltage will enable the device. For producing constant, non-pulsating output current compare to conventional pulse width modulation (PWM) dimming scheme, the AW9358B incorporates a 4-bit DAC for brightness control to program the output current at 16 continuous steps: 20~1.25mA. Table 1 shows detail for current setting.

Table 1 Current Setting

| EN Rise Edge Number | Current (mA) | EN Rise Edge Number | Current (mA) |
|---------------------|--------------|---------------------|--------------|
| 1 | 20 | 9 | 10 |
| 2 | 18.75 | 10 | 8.75 |
| 3 | 17.5 | 11 | 7.5 |
| 4 | 16.25 | 12 | 6.25 |
| 5 | 15 | 13 | 5 |
| 6 | 13.75 | 14 | 3.75 |
| 7 | 12.5 | 15 | 2.5 |
| 8 | 11.25 | 16 | 1.25 |

The figure 5 shows the detail operation of 16-steps brightness control. When 1-wire pulse counting dimming is used, the startup time TON is recommended to be greater than 20 μ s for enabling the device, the pulse high time THI recommended to be greater than 0.5 μ s, and the pulse low time TLO is recommended to be greater than 0.5 μ s and less than 500 μ s. A constant current is sourced as long as the EN signal remains high. The shutdown feature reduces quiescent current to less than 0.1 μ A.

Deglitch Circuit

In portable applications such as mobile phones, digital cameras and other portable applications, the interference between the signal lines on the PCB is inevitable. The AW9358B has an internal deglitch circuit for filtering the noise of the EN input. Internal Deglitch circuit can eliminate EN pin less than 80ns high level glitch, effectively avoid the false trigger of 1-wire pulse counting dimming caused by the interference of external circuit.

Over Thermal Protection

The AW9358B has an internal over thermal protection circuit. The over temperature circuit will turn off the output current to decrease the power dissipation when the junction temperature exceeds 150°C and will resume the output circuit when the junction temperature falls below 130°C

Application Information

LED Brightness Dimming Control

The AW9358B incorporates a 1-wire pulse count dimming to eliminate the switch noise. The principle of 1-wire pulse count dimming: the AW9358B has 4 internal DAC circuit, which are used to count the number of rising edges of the EN pin pulse signal to set the LED current(Figure 5 and Table 1).

1-wire pulse dimming adjust the LED current method: when the present current is more than the target current, two corresponding pulse number subtraction can be from the current LED current adjustment to the target current:

$$n = N_{to} - N_{from}.$$

For example, adding 13-9=4 pulses changes the LED current from 10mA (rising edges: 9) to 5mA (rising edges: 13) as shown in Figure 6.

Since the AW9358B is a 16 step linear dimming, one cycle per 16 pulse. For the current less than the target current, the number of pulses needed to increase is calculated by adding the 16 pulse and then the callback method:

$$n = N_{to} + 16 - N_{from}.$$

For example, adding 1+16-9=8 pulses changes the LED current from 10mA (rising edges: 9) to 20mA (rising edges: 1) as shown in Figure 7.

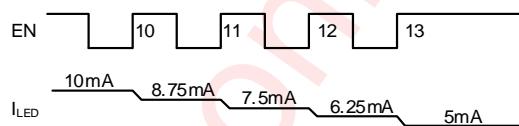


Figure 6 Programming Example for LED Current from 10mA to 5mA

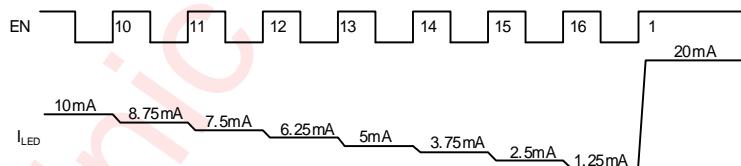


Figure 7 Programming Example for LED Current from 10mA to 20mA

Efficiency

The AW9358B is a parallel white LED driver with ultra low dropout constant-current source. Based on the 20mA current of each LED, the AW9358B only need 50mV (typical) dropout voltage at least. Compared with other LED driver device, higher efficiency is obtained.

The system efficiency, defined as the ratio between the LED's power and the input power can be calculated simply as the following:

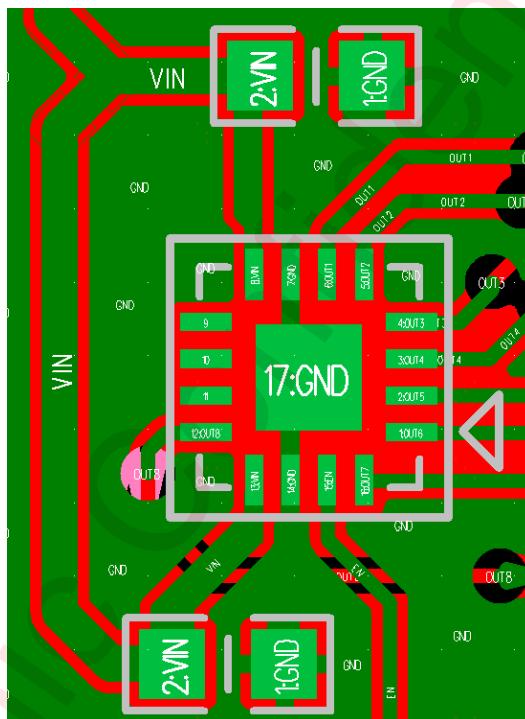
$$\eta = \frac{P_{OUT}}{P_{IN}} = \frac{V_F * I_{OUT}}{V_{IN} * I_{IN}} \approx \frac{V_F * I_{OUT}}{V_{IN} * I_{OUT}} = \frac{V_F}{V_{IN}}$$

Where V_F is the LED forward voltage, $V_{IN} = V_F + V_{DO}$, V_{DO} is the dropout voltage needed in the current source. For example, when $V_{DO}=3.2V$ (20mA) $V_{IN}=3.4V$, the η is about 94%, greater than other type of LED driver.

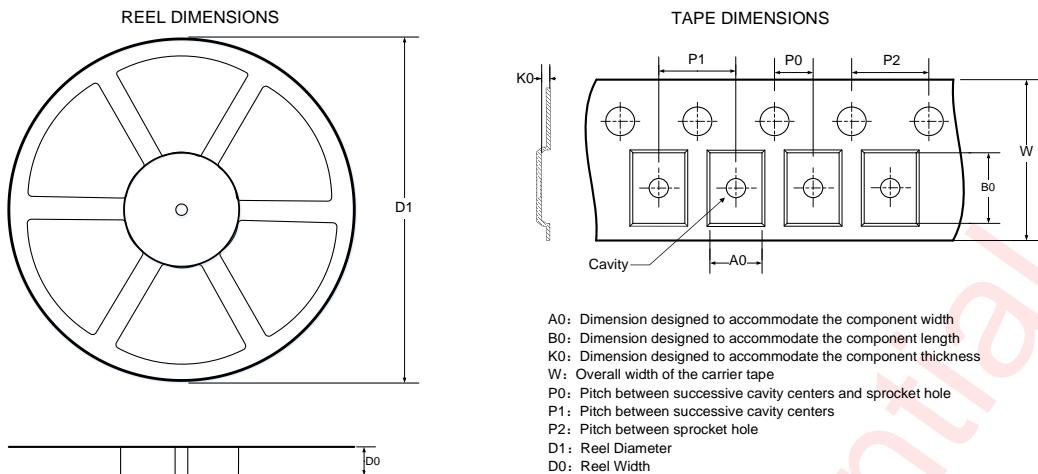
PCB Layout Consideration

The AW9358B is a parallel white LED driver with ultra low dropout constant-current source. The following guidelines should be strictly followed for the layout of the AW9358B:

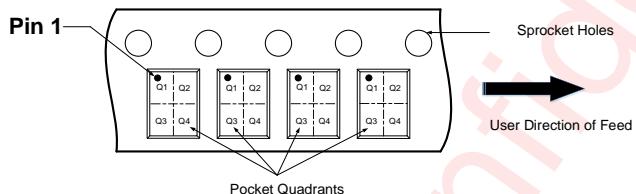
1. Place all peripheral components as close to the device as possible. Place C_{IN} close to the VIN and GND.
2. The power line contact VIN and LED anode must wide, to reduce the influence of parasitic inductance and parasitic resistance.
3. Input capacitor C_{IN} need to near pin 8 and pin 13 of AW9358B, At the same time, the line between the IC corresponding pins and capacitor pad as wide as possible, to reduce noise and EMI interference.
4. In order to obtain a better thermal performance and noise performance, the chip thermal pad and GND must be connected directly to the PCB of the large area spread formation, and in the thermal pad below the floor layer through the through hole connected to the PCB of the middle layer of ground.



Tape And Reel Information



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



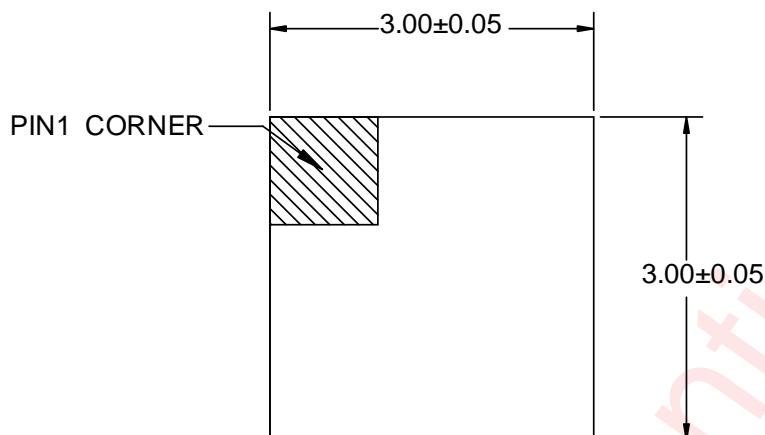
Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

DIMENSIONS AND PIN1 ORIENTATION

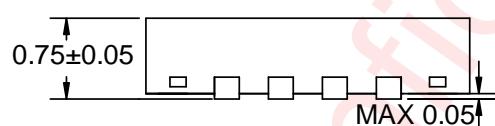
| D1 (mm) | D0 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|---------|---------|---------|---------|---------|---------|---------|---------|--------|---------------|
| 330 | 12.4 | 3.3 | 3.3 | 1.1 | 2 | 8 | 4 | 12 | Q1 |

All dimensions are nominal

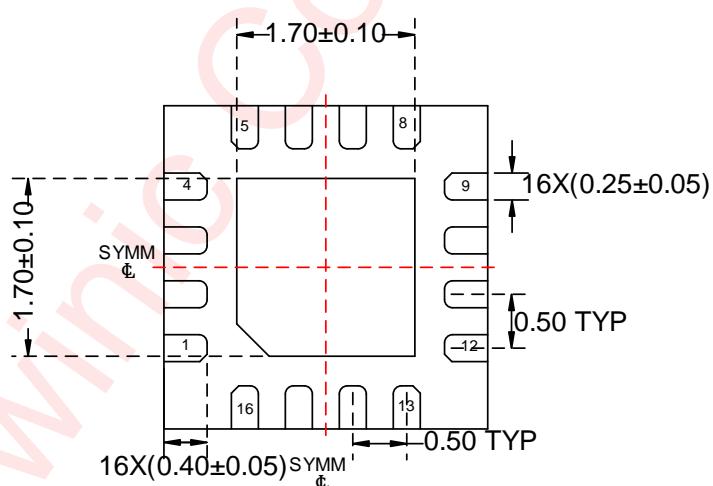
Package Description



TOP VIEW



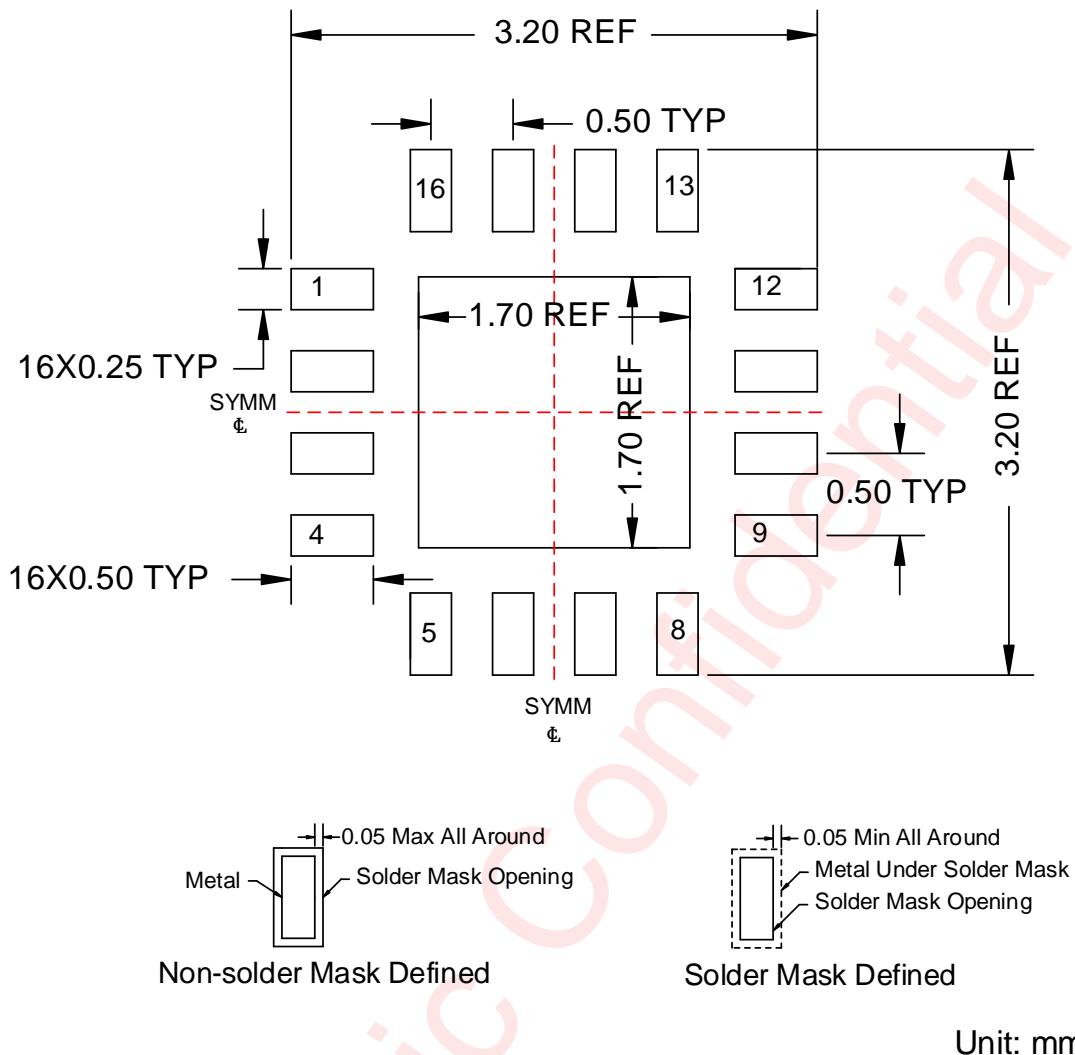
SIDE VIEW



BOTTOM VIEW

Unit: mm

Land Pattern



Revision History

| Date | Vision | Description |
|-----------|--------|----------------------|
| Dec. 2021 | V1.0 | Officially released. |

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